RENESAS

DATASHEET

EL5104, EL5105, EL5204, EL5205, EL5304

700MHz Slew-Enhanced VFAs

FN7332 Rev 8.00 May 25, 2016

The EL5104, EL5105, EL5204, EL5205, and EL5304 represent high speed voltage feedback amplifiers based on the current feedback amplifier architecture. This gives the typical high slew rate benefits of a CFA family along with the stability and ease of use associated with the VFA type architecture. This family is available in single, dual, and triple versions, with 200MHz, 400MHz, and 700MHz versions. This family operates on single 5V or \pm 5V supplies from minimum supply current. The EL5104 and EL5204 also feature an output enable function, which can be used to put the output in to a high-impedance mode. This enables the outputs of multiple amplifiers to be tied together for use in multiplexing applications.

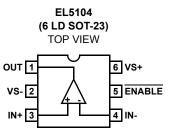
Features

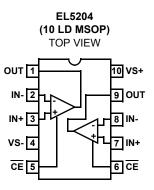
- Specified for 5V or ±5V applications
- Power-down to 17µA
- -3dB bandwidth = 700MHz
- ±0.1dB bandwidth = 45MHz
- Low supply current = 9.5mA
- Slew rate = 7000V/µs
- Low offset voltage = 10mV max
- Output current = 160mA
- A_{VOL} = 1400
- Diff gain/phase = 0.01%/0.02°
- · Pb-free plus anneal available (RoHS compliant)

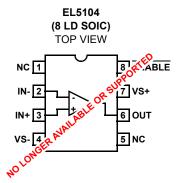
Applications

- Video amplifiers
- PCMCIA applications
- A/D drivers
- · Line drivers
- · Portable computers
- · High speed communications
- · RGB applications
- Broadcast equipment
- · Active filtering

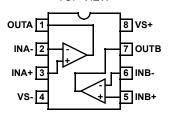


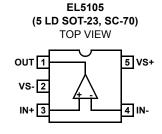


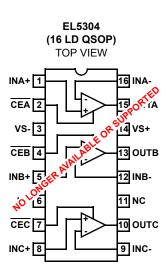




EL5205 (8 LD SOIC, MSOP) TOP VIEW







Ordering Information

PART NUMBER	PART MARKING	TAPE & REEL	PACKAGE	PKG. DWG. #
EL5104ISZ (Note) (No longer available, recommended replacement: EL5104IWZ-T7)	5104ISZ	-	8 Ld SOIC (150 mil) (Pb-Free)	MDP0027
EL5104ISZ-T7 (Note) (No longer available, recommended replacement: EL5104IWZ-T7)	5104ISZ	7"	8 Ld SOIC (150 mil) (Pb-Free)	MDP0027
EL5104ISZ-T13 (Note) (No longer available, recommended replacement: EL5104IWZ-T7)	5104ISZ	13"	8 Ld SOIC (150 mil) (Pb-Free)	MDP0027
EL5104IWZ-T7 (Note)	BAEA	7" (3k pcs)	6 Ld SOT-23 (Pb-Free)	P5.064A
EL5104IWZ-T7A (Note)	BAEA	7" (250 pcs)	6 Ld SOT-23 (Pb-Free)	P5.064A
EL5105IC (No longer available or supported)	С	-	5 Ld SC-70 (1.25mm)	P5.049
EL5105IWZ-T7 (Note)	BBMA	7" (3k pcs)	5 Ld SOT-23 (Pb-Free)	P5.064A
EL5105IWZ-T7A (Note)	BBMA	7" (250 pcs)	5 Ld SOT-23 (Pb-Free)	P5.064A
EL5204IYZ (Note)	BAAAF	-	10 Ld MSOP (3.0mm) (Pb-Free)	MDP0043
EL5204IYZ-T7 (Note)	BAAAF	7"	10 Ld MSOP (3.0mm) (Pb-Free)	MDP0043
EL5204IYZ-T13 (Note)	BAAAF	13"	10 Ld MSOP (3.0mm) (Pb-Free)	MDP0043



Ordering Information (Continued)

PART NUMBER	PART MARKING	TAPE & REEL	PACKAGE	PKG. DWG. #
EL5205ISZ (Note)	5205ISZ	-	8 Ld SOIC (150 mil) (Pb-Free)	MDP0027
EL5205ISZ-T7 (Note)	5205ISZ	7"	8 Ld SOIC (150 mil) (Pb-Free)	MDP0027
EL5205ISZ-T13 (Note)	5205ISZ	13"	8 Ld SOIC (150 mil) (Pb-Free)	MDP0027
EL5304IU (No longer available or supported)	5304IU	-	16 Ld QSOP (150 mil)	MDP0040
EL5304IU-T7 (No longer available or supported)	5304IU	7"	16 Ld QSOP (150 mil)	MDP0040
EL5304IU-T13 (No longer available or supported)	5304IU	13"	16 Ld QSOP (150 mil)	MDP0040
EL5304IUZ (Note) (No longer available or supported)	5304IUZ	-	16 Ld QSOP (150 mil) (Pb-Free)	MDP0040
EL5304IUZ-T7 (Note) (No longer available or supported)	5304IUZ	7"	16 Ld QSOP (150 mil) (Pb-Free)	MDP0040
EL5304IUZ-T13 (Note) (No longer available or supported)	5304IUZ	13"	16 Ld QSOP (150 mil) (Pb-Free)	MDP0040

NOTE: Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.



Absolute Maximum Ratings (T_A = +25°C)

Supply Voltage between V _S + and GND	. 13.2V
Input Voltage	±V _S
Differential Input Voltage	±4V
Maximum Output Current	. 80mA
V _S + to V _S - Maximum Slew Rate	. 1V/µs

Thermal Information

Storage Temperature Range	-65°C to +150°C
Ambient Operating Temperature Range	40°C to +85°C
Operating Junction Temperature	+150°C
Pb-free reflow profile	see link below
http://www.intersil.com/pbfree/Pb-FreeReflow.asp	0

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typical values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore: $T_J = T_C = T_A$

DC Electrical Specifications $V_S = \pm 5V$, GND = 0V, $T_A = +25^{\circ}$ C, $V_{CM} = 0V$, $V_{OUT} = 0V$, $V_{ENABLE} =$ GND or OPEN, Unless Otherwise Specified.

PARAMETER	DESCRIPTION	CONDITIONS	MIN	ТҮР	MAX	UNIT
V _{OS}	Offset Voltage	EL5104, EL5105, EL5204, EL5205	-10	3	10	mV
		EL5304	-18	5	18	mV
TCV _{OS}	Offset Voltage Temperature Coefficient	Measured from T _{MIN} to T _{MAX}		10		µV/°C
IB	Input Bias Current	V _{IN} = 0V		8	30	μA
I _{OS}	Input Offset Current	V _{IN} = 0V		4	15	μA
TCI _{OS}	Input Bias Current Temperature Coefficient	Measured from T_{MIN} to T_{MAX}		50		nA/°C
PSRR	Power Supply Rejection Ratio		60	70		dB
CMRR	Common Mode Rejection Ratio	V _{CM} from -3V to +3V	56	62		dB
CMIR	Common Mode Input Range	Guaranteed by CMRR test	-3		+3	V
R _{IN}	Input Resistance	Common mode	50	120		kΩ
C _{IN}	Input Capacitance	SO package		1		pF
I _{S,ON}	Supply Current - Enabled	Per amplifier	8.5	9.5	11	mA
I _{S,OFF}	Supply Current - Shut Down	V _S +, per amplifier	+1	0	+25	μA
		V _S -, per amplifier	-25	17	-1	μA
PSOR	Power Supply Operating Range		4		13.2	V
AVOL	Open Loop Gain	$R_L = 1k\Omega$ to GND	55	65		dB
		$R_L = 150\Omega$ to GND		60		dB
V _{OP}	Positive Output Voltage Swing	$R_L = 150\Omega$ to 0V	3.6	3.8		V
V _{ON}	Negative Output Voltage Swing	$R_L = 150\Omega$ to 0V		-3.8	-3.6	V
IOUT	Output Current	$R_L = 10\Omega$ to 0V	±90	±160		mA
V _{IH-EN}	ENABLE Pin Voltage for Power Up		(V _S +) -5		(V _S +) -3	V
V _{IL-EN}	ENABLE Pin Voltage for Shut Down		(V _S +) -1		V _S +	V

$\begin{array}{l} \textbf{Closed Loop AC Electrical Specifications} \\ V_{S} = +5V, \\ \textbf{GND} = 0V, \\ T_{A} = +25^{\circ}\text{C}, \\ V_{CM} = +1.5V, \\ V_{OUT} = +1.5V, \\ V_{CLAMP} = +5V, \\ V_{ENABLE} = 0V, \\ \textbf{A}_{V} = +1, \\ \textbf{R}_{F} = 0\Omega, \\ \textbf{R}_{L} = 150\Omega \\ \textbf{to GND pin, unless otherwise specified.} \end{array}$

PARAMETER	DESCRIPTION	CONDITIONS	MIN	TYP	MAX	UNIT
BW	-3dB Bandwidth (V _{OUT} = 200mV _{P-P})	$V_{S} = \pm 5V$, $A_{V} = 1$, $R_{F} = 0\Omega$		700		MHz
SR	Slew Rate	R_L = 100 Ω , V_{OUT} = -3V to +3V	2000	3000	7000	V/µs
t _R , t _F	Rise Time, Fall Time	±0.1V step		0.4		ns
OS	Overshoot	±0.1V step		10		%
t _{PD}	Propagation Delay	±0.1V step		0.4		ns
t _S	0.1% Settling Time	$V_{S} = \pm 5V, R_{L} = 500\Omega, A_{V} = 1, V_{OUT} = \pm 2.5V$		7		ns
dG	Differential Gain	$A_V = 2$, $R_L = 150\Omega$, $V_{INDC} = -1$ to +1V		0.01		%
dP	Differential Phase	$A_V = 2$, $R_L = 150\Omega$, $V_{INDC} = -1$ to +1V		0.02		٥
e _N	Input Noise Voltage	f = 10kHz		10		nV/√Hz
i _N	Input Noise Current	f = 10kHz		54		pA/√Hz
t _{DIS}	Disable Time			180		ns
t _{EN}	Enable Time			650		ns
I _{EN}	Enable Pin Current	Enabled, V _{EN} = 0V	-1		1	μA
		Disabled, V _{EN} = 5V	1		25	μA



Typical Performance Curves

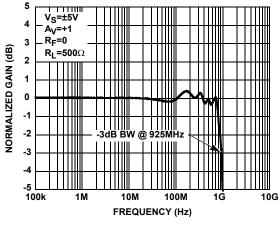
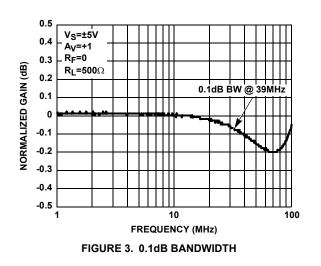
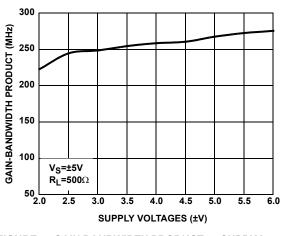
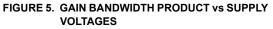
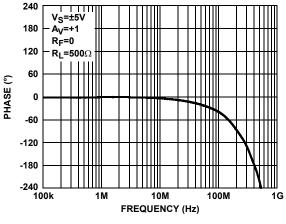


FIGURE 1. GAIN vs FREQUENCY (-3dB BANDWIDTH)

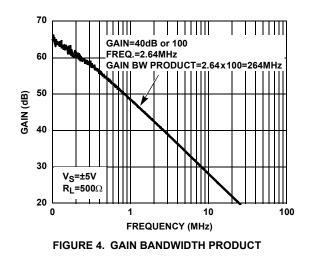












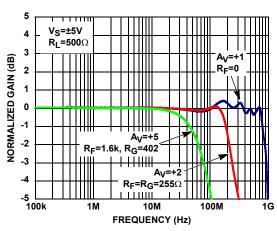


FIGURE 6. GAIN vs FREQUENCY FOR VARIOUS +Av



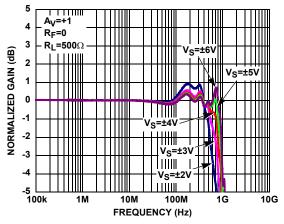


FIGURE 7. GAIN vs FREQUENCY FOR VARIOUS ±Vs

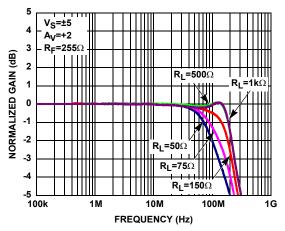


FIGURE 9. GAIN vs FREQUENCY FOR VARIOUS RL (Av=+2)

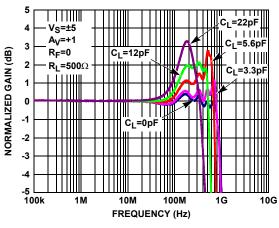


FIGURE 11. GAIN vs FREQUENCY FOR VARIOUS C_L (A_V=+1)

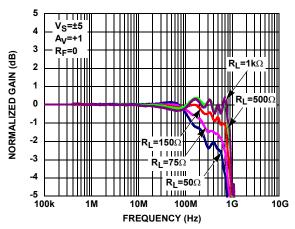


FIGURE 8. GAIN vs FREQUENCY FOR VARIOUS RL (Av=+1)

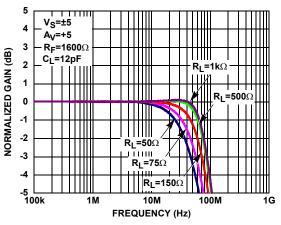
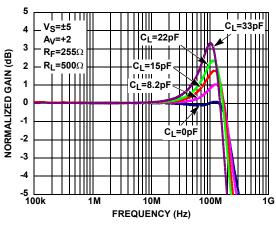


FIGURE 10. GAIN vs FREQUENCY FOR VARIOUS RL (Av=+5)







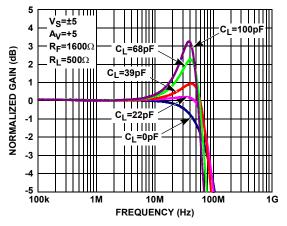


FIGURE 13. GAIN vs FREQUENCY FOR VARIOUS CL (Av=+5)

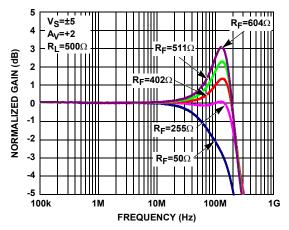


FIGURE 15. GAIN vs FREQUENCY FOR VARIOUS R_F (A_V = +2)

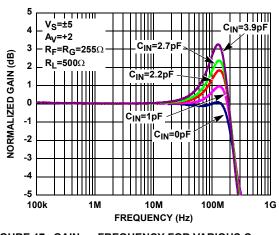


FIGURE 17. GAIN vs FREQUENCY FOR VARIOUS $C_{IN(-)}$ (A_V = +2)

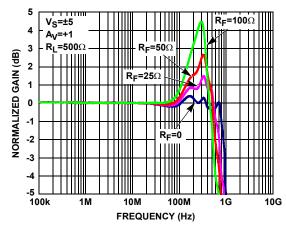


FIGURE 14. GAIN vs FREQUENCY FOR VARIOUS R_F (A_V=+1)

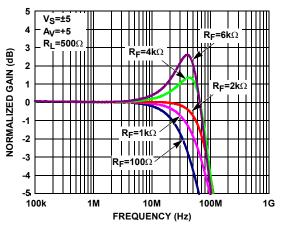
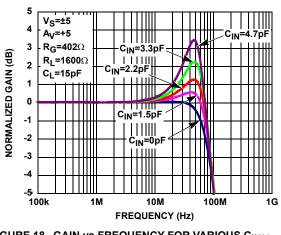
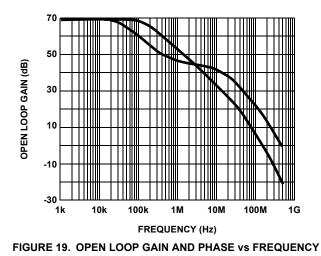
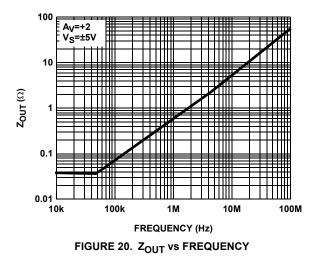


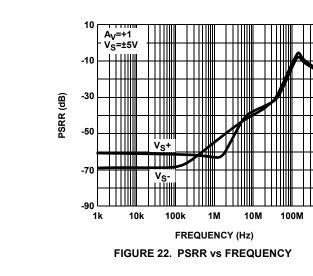
FIGURE 16. GAIN vs FREQUENCY FOR VARIOUS R_F (A_V = +5)

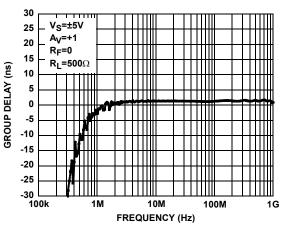














A_V=+5 ٧s =±5\ -30 CMRR (dB) -50 -70 -90 -110 1k 10k 100k 1M 10M 100M 1G **FREQUENCY** (Hz)

FIGURE 21. CMRR vs FREQUENCY

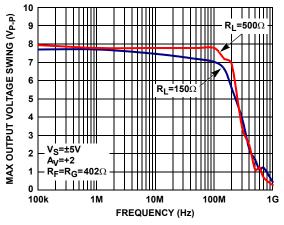


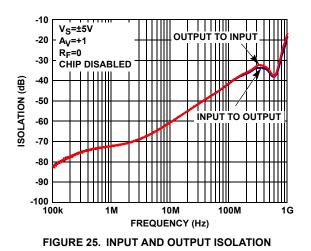
FIGURE 23. MAX OUTPUT VOLTAGE SWING vs FREQUENCY

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1G



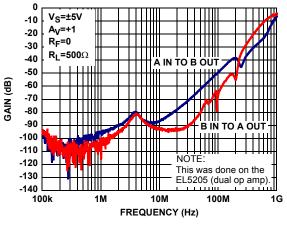


FIGURE 26. CHANNEL TO CHANNEL ISOLATION

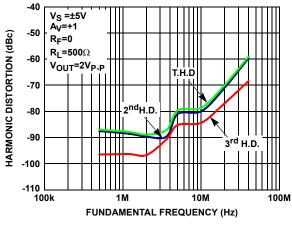
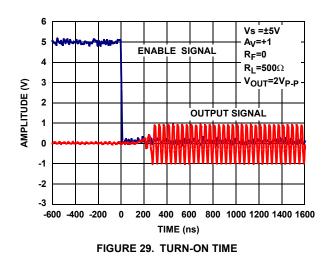


FIGURE 27. HARMONIC DISTORTION vs FREQUENCY



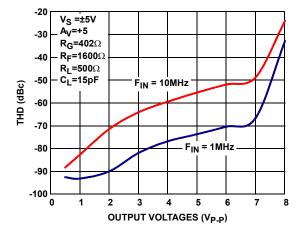
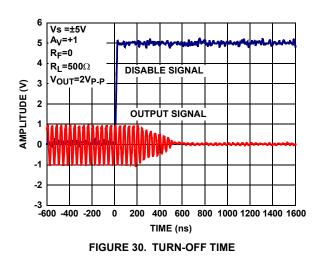


FIGURE 28. TOTAL HARMONIC DISTORTION vs OUTPUT VOLTAGES





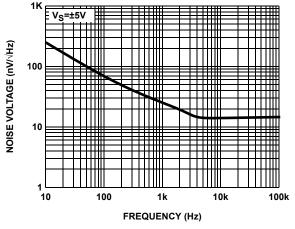


FIGURE 31. EQUIVALENT NOISE VOLTAGE vs FREQUENCY

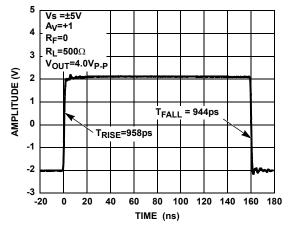


FIGURE 33. LARGE SIGNAL STEP RESPONSE RISE & FALL TIME

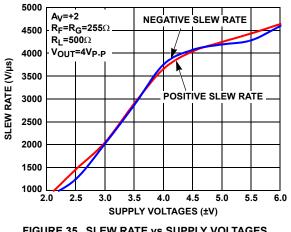


FIGURE 35. SLEW RATE vs SUPPLY VOLTAGES

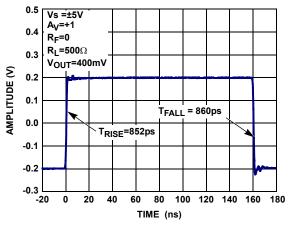


FIGURE 32. SMALL SIGNAL STEP RESPONSE_RISE & FALL TIME

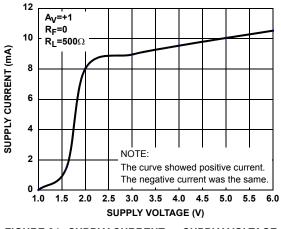


FIGURE 34. SUPPLY CURRENT vs SUPPLY VOLTAGE

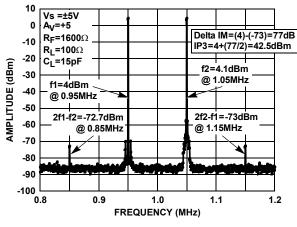
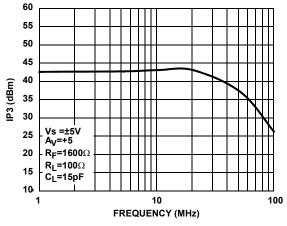


FIGURE 36. THIRD ORDER IMD INTERCEPT (IP3)







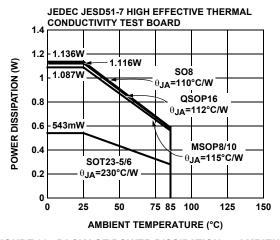


FIGURE 38. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE

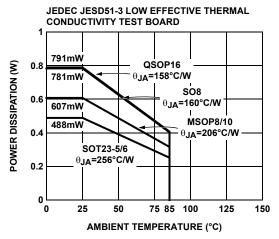


FIGURE 39. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE

RENESAS

Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to the web to make sure that you have the latest revision.

DATE	REVISION	CHANGE
May 25, 2016	FN7332.8	- Updated Ordering Information Table on page 2.
October 20, 2015	FN7332.7	 Updated Ordering Information Table on page 2. Added Revision History. Added About Intersil Verbiage. POD MDP0038 obsoleted and replaced by P5.064A latest revision.

About Intersil

Intersil Corporation is a leading provider of innovative power management and precision analog solutions. The company's products address some of the largest markets within the industrial and infrastructure, mobile computing and high-end consumer markets.

For the most updated datasheet, application notes, related documentation and related parts, please see the respective product information page found at <u>www.intersil.com</u>.

You may report errors or suggestions for improving this datasheet by visiting www.intersil.com/ask.

Reliability reports are also available from our website at www.intersil.com/support.

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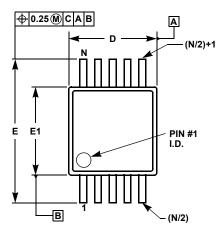
Intersil products are manufactured, assembled and tested utilizing ISO9001 quality systems as noted in the quality certifications found at www.intersil.com/en/support/qualandreliability.html

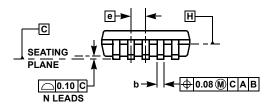
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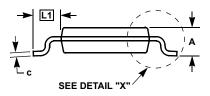
For information regarding Intersil Corporation and its products, see www.intersil.com

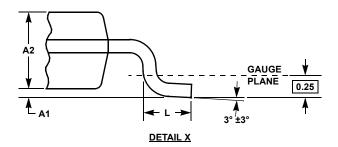


Mini SO Package Family (MSOP)









MDP0043

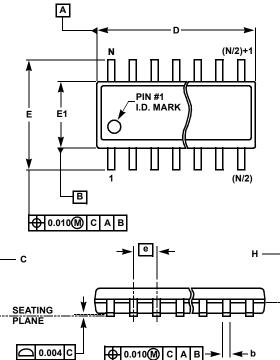
MINI SO PACKAGE FAMILY

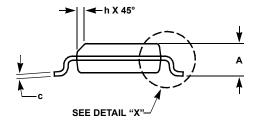
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SYMBOL	MSOP8	MSOP10	TOLERANCE	NOTES
А	1.10	1.10	Max.	-
A1	0.10	0.10	±0.05	-
A2	0.86	0.86	±0.09	-
b	0.33	0.23	+0.07/-0.08	-
С	0.18	0.18	±0.05	-
D	3.00	3.00	±0.10	1, 3
E	4.90	4.90	±0.15	-
E1	3.00	3.00	±0.10	2, 3
е	0.65	0.50	Basic	-
L	0.55	0.55	±0.15	-
L1	0.95	0.95	Basic	-
Ν	8	10	Reference	-
				Rev. D 2/07

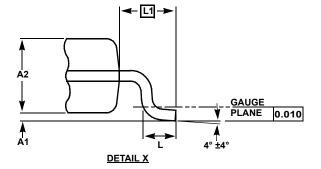
- 1. Plastic or metal protrusions of 0.15mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25mm maximum per side are not included.
- 3. Dimensions "D" and "E1" are measured at Datum Plane "H".
- 4. Dimensioning and tolerancing per ASME Y14.5M-1994.



Small Outline Package Family (SO)







MDP0027

SMALL OUTLINE PACKAGE FAMILY (SO)

	INCHES								
SYMBOL	SO-8	SO-14	SO16 (0.150")	SO16 (0.300") (SOL-16)	SO20 (SOL-20)	SO24 (SOL-24)	SO28 (SOL-28)	TOLERANCE	NOTES
А	0.068	0.068	0.068	0.104	0.104	0.104	0.104	MAX	-
A1	0.006	0.006	0.006	0.007	0.007	0.007	0.007	±0.003	-
A2	0.057	0.057	0.057	0.092	0.092	0.092	0.092	±0.002	-
b	0.017	0.017	0.017	0.017	0.017	0.017	0.017	±0.003	-
С	0.009	0.009	0.009	0.011	0.011	0.011	0.011	±0.001	-
D	0.193	0.341	0.390	0.406	0.504	0.606	0.704	±0.004	1, 3
Е	0.236	0.236	0.236	0.406	0.406	0.406	0.406	±0.008	-
E1	0.154	0.154	0.154	0.295	0.295	0.295	0.295	±0.004	2, 3
е	0.050	0.050	0.050	0.050	0.050	0.050	0.050	Basic	-
L	0.025	0.025	0.025	0.030	0.030	0.030	0.030	±0.009	-
L1	0.041	0.041	0.041	0.056	0.056	0.056	0.056	Basic	-
h	0.013	0.013	0.013	0.020	0.020	0.020	0.020	Reference	-
Ν	8	14	16	16	20	24	28	Reference	-

Rev. M 2/07

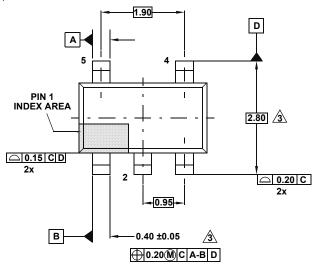
- 1. Plastic or metal protrusions of 0.006" maximum per side are not included.
- 2. Plastic interlead protrusions of 0.010" maximum per side are not included.
- 3. Dimensions "D" and "E1" are measured at Datum Plane "H".
- 4. Dimensioning and tolerancing per ASME Y14.5M-1994



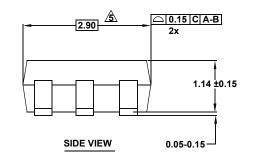
Package Outline Drawing

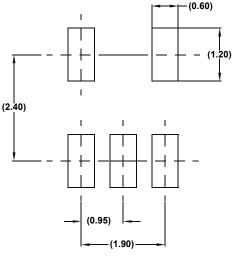
P5.064A

5 LEAD SMALL OUTLINE TRANSISTOR PLASTIC PACKAGE Rev 0, 2/10

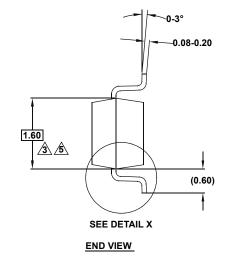


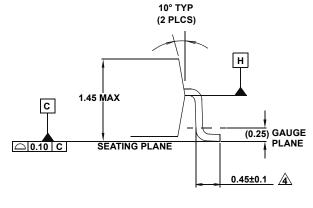
TOP VIEW





TYPICAL RECOMMENDED LAND PATTERN



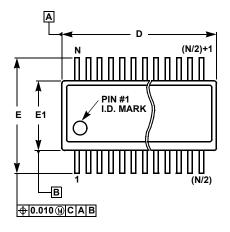


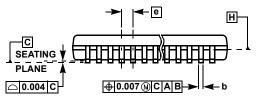


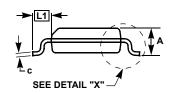
- 1. Dimensions are in millimeters. Dimensions in () for Reference Only.
- 2. Dimensioning and tolerancing conform to ASME Y14.5M-1994.
- 3. Dimension is exclusive of mold flash, protrusions or gate burrs.
- 4. Foot length is measured at reference to guage plane.
- **5.** This dimension is measured at Datum "H".
- 6. Package conforms to JEDEC MO-178AA.

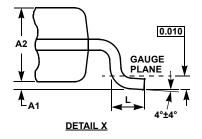


Quarter Size Outline Plastic Packages Family (QSOP)









MDP0040

QUARTER SIZE OUTLINE PLASTIC PACKAGES FAMILY

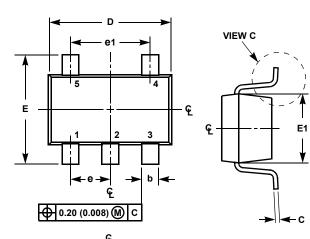
	INCHES				
SYMBOL	QSOP16	QSOP24	QSOP28	TOLERANCE	NOTES
А	0.068	0.068	0.068	Max.	-
A1	0.006	0.006	0.006	±0.002	-
A2	0.056	0.056	0.056	±0.004	-
b	0.010	0.010	0.010	±0.002	-
с	0.008	0.008	0.008	±0.001	-
D	0.193	0.341	0.390	±0.004	1, 3
E	0.236	0.236	0.236	±0.008	-
E1	0.154	0.154	0.154	±0.004	2, 3
е	0.025	0.025	0.025	Basic	-
L	0.025	0.025	0.025	±0.009	-
L1	0.041	0.041	0.041	Basic	-
Ν	16	24	28	Reference	-
				Re	ev. F 2/07

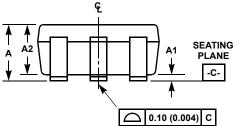
- 2. Plastic interlead protrusions of 0.010" maximum per side are not included.
- 3. Dimensions "D" and "E1" are measured at Datum Plane "H".
- 4. Dimensioning and tolerancing per ASME Y14.5M-1994.

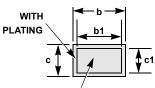


^{1.} Plastic or metal protrusions of 0.006" maximum per side are not included.

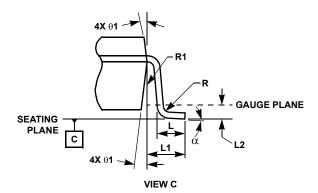
Small Outline Transistor Plastic Packages (SC70-5)











P5.049

5 LEAD SMALL OUTLINE TRANSISTOR PLASTIC PACKAGE

	INC	HES	MILLIM		
SYMBOL	MIN	MAX	MIN	MAX	NOTES
А	0.031	0.043	0.80	1.10	-
A1	0.000	0.004	0.00	0.10	-
A2	0.031	0.039	0.80	1.00	-
b	0.006	0.012	0.15	0.30	-
b1	0.006	0.010	0.15	0.25	
С	0.003	0.009	0.08	0.22	6
c1	0.003	0.009	0.08	0.20	6
D	0.073	0.085	1.85	2.15	3
E	0.071	0.094	1.80	2.40	-
E1	0.045	0.053	1.15	1.35	3
е	0.025	0.0256 Ref		Ref	-
e1	0.051	0.0512 Ref		Ref	-
L	0.010	0.018	0.26	0.46	4
L1	0.017	' Ref.	0.420) Ref.	-
L2	0.006	BSC	0.15	BSC	
α	0 ⁰	8 ⁰	0 ⁰	8 ⁰	-
Ν	Ę	5	Į	5	5
R	0.004	-	0.10	-	
R1	0.004	0.010	0.15	0.25	
		-			Rev. 2 9/0

NOTES:

1. Dimensioning and tolerances per ASME Y14.5M-1994.

- 2. Package conforms to EIAJ SC70 and JEDEC MO-203AA.
- 3. Dimensions D and E1 are exclusive of mold flash, protrusions, or gate burrs.
- 4. Footlength L measured at reference to gauge plane.
- 5. "N" is the number of terminal positions.
- 6. These Dimensions apply to the flat section of the lead between 0.08mm and 0.15mm from the lead tip.
- 7. Controlling dimension: MILLIMETER. Converted inch dimensions are for reference only.

